PC	N Number:	202	40227	009	0.1	PCN Da	ite:	Febru	uary 27, 2024	
Tit	le: Datasheet for	BQ2	5620/E	3Q2	5622				,	
Cu	stomer Contact:				ement		De	pt:	Quality Services	
Pro	pposed 1 <sup>st</sup> Ship Da	te:	May 2	27,	2024				, - ,	
Ch	ange Type:		-							
	Assembly Site	Design Wafe			Wafer	· Bump Site				
	Assembly Process			X	X Data Sheet			Wafer	· Bump Material	
	Assembly Materials				Part number change			Wafer	· Bump Process	
Mechanical Specification					Test Site				· Fab Site	
Packing/Shipping/Labeling					Test Process			Wafer	· Fab Materials	
<u> </u>								Wafer	Fab Process	
	Notification Details									
De	scription of Chang	je:								
	The product datasheet(s) is being updated as summarized below.    Texas   BQ25620, BQ25622									
С	Changes from Revision B (January 2024) to Revision C (February 2024) Page									
Changed T <sub>TOP OFF</sub> Typical and Maximum Limit										
Changed T <sub>SAFETY TRKCHG</sub> Typical and Maximum Limit							16			
•					Maximum Limit					
					m Limit					
					ım Limit					
				um Limit						
Changed Toon_RST Typical and Maximus     Changed T <sub>BATEFT</sub> RST Typical Value										
•	Changed T <sub>LP_WDT</sub> Typic									
•	Changed T <sub>WDT</sub> Typical							16		
Changed recommended values of RT1 and RT2 in Section 8.3.5.4.2										
•	Added I <sup>2</sup> C timing requirements for fast mode and fast mode plus in Section 8.5.1									
<ul> <li>Changed TOPOFF_TMR values in Charge_Control_0 Register Description, PRECHG_TMR and CHG_TMR values in Charge_Timer_Control Register Description, and WATCHDOG values in Charger_Control_1</li> </ul>										
	Register Description									
Updated behavior of IBAT_ADC in IBAT_ADC Register Description										
The datasheet number will be changing.										
Device Family				Change From:				Change To:		
BQ25620/BQ25622				SLUSEG2B			SLUSEG2C			
These changes may be reviewed at the datasheet links provided. <a href="http://www.ti.com/product/BQ25620">http://www.ti.com/product/BQ25620</a> Reason for Change:  To accurately reflect device characteristics										
Τn	accurately reflect de	vice i	charac	teri	stics					

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
Electrical specification performance changes as indicated above.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
BQ25620RYKR	BQ25622RYKR								

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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